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## FCP16N60 / FCPF16N60 N-Channel SuperFET<sup>®</sup> MOSFET **600 V, 16 A, 260 m**Ω

#### **Features**

- 650V @ T<sub>J</sub> = 150°C
- Typ. R<sub>DS(on)</sub> = 220 mΩ
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 55 nC )
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 110 pF )
- · 100% Avalanche Tested

#### Applications

- Solar Inverter
- AC-DC Power Supply



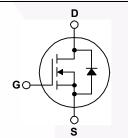
FCP16N60 / FCPF16N60 — N-Channel SuperFET<sup>®</sup> MOSFET

### Description

SuperFET<sup>®</sup> MOSFET is Fairchild Semiconductor's first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low onresistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.







#### **Absolute Maximum Ratings**

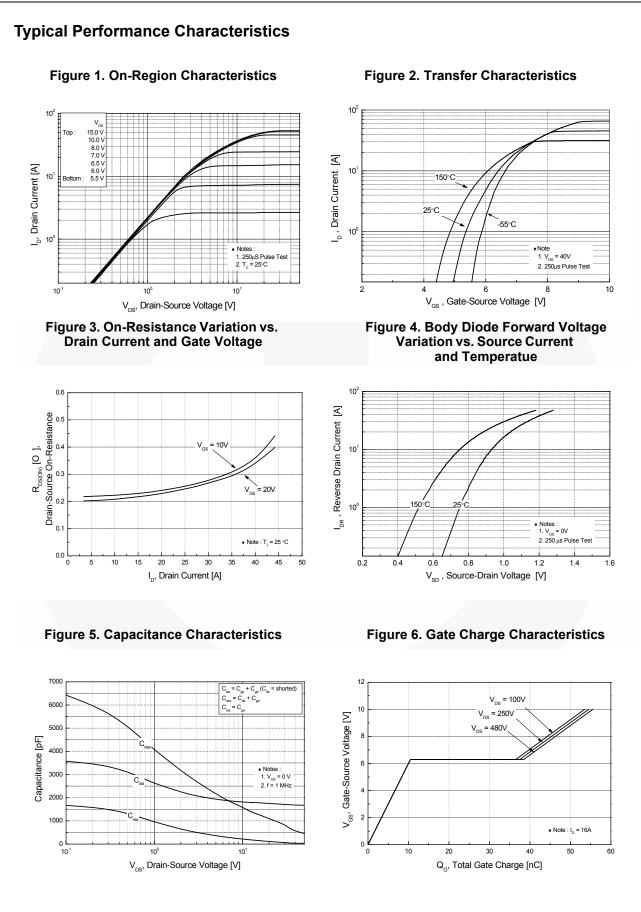
Symbol	Parameter			FCP16N60	FCPF16N60	Unit	
V <sub>DSS</sub>	Drain-Source Voltage			6	V		
ID	Drain Current	- Continuous (T <sub>C</sub> = 25°C) - Continuous (T <sub>C</sub> = 100°C)		16 10.1	16* 10.1*	A A	
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	48	48*	A	
V <sub>GSS</sub>	Gate-Source Voltage			± 30		V	
E <sub>AS</sub>	Single Pulsed Avalanche Energy		(Note 2)	450		mJ	
I <sub>AR</sub>	Avalanche Current		(Note 1)	16		А	
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	20.8		mJ	
dv/dt	Peak Diode Recovery dv/dt (Note		(Note 3)	4.5		V/ns	
P <sub>D</sub>	Power Dissipation	(T <sub>C</sub> = 25°C) - Derate Above 25°C		167 1.33	37.9 0.3	W W/°C	
T <sub>J,</sub> T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150		°C		
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			3	°C		

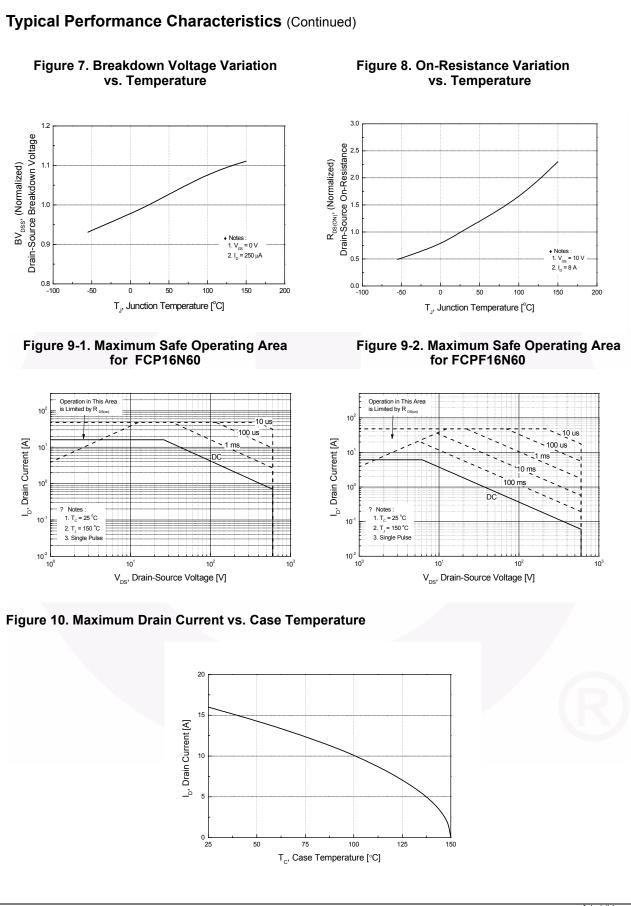
\*Drain current limited by maximum junction temperature.

#### Thermal Characteristics

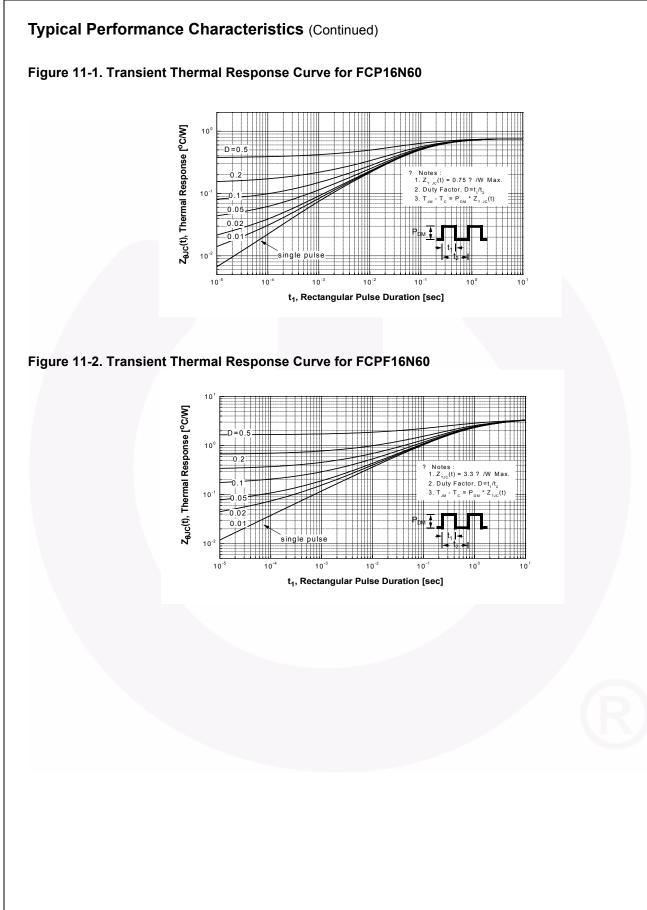
Symbol	Parameter	FCP16N60	FCPF16N60	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.75	3.3	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient	62.5	62.5	°C/W

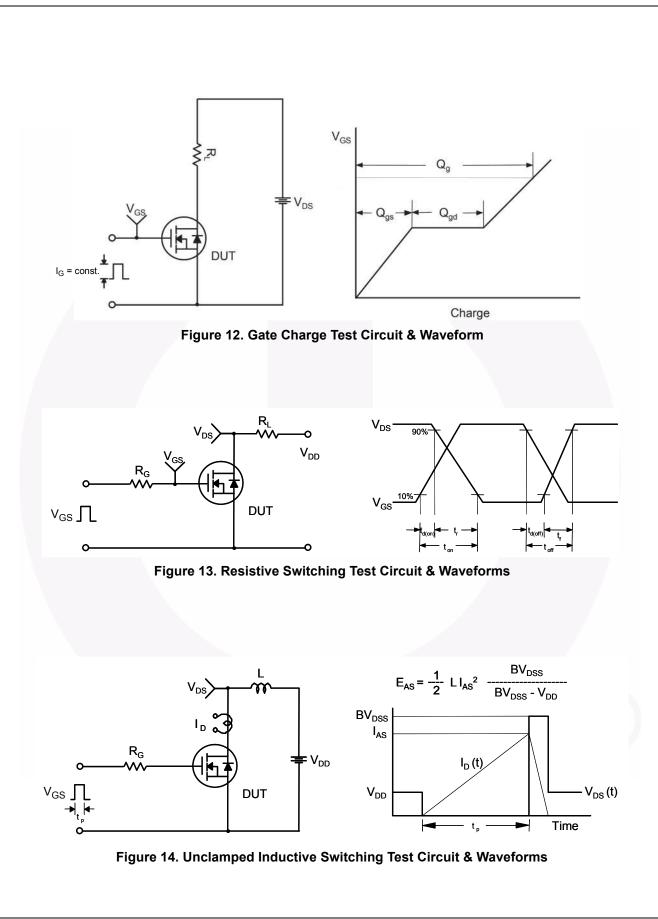
Part Num	nber	Top Mark	Packag	e Packing Method	Reel Size	Тар	e Width	Qua	ntity
		FCP16N60	TO-220	D Tube	N/A		N/A	50 units	
		TO-220				N/A		50 units	
Electrica	l Chara	acteristics T <sub>C</sub> = 2	5ºC unless	s otherwise noted.					
Symbol		Parameter		Test Condition	ons	Min.	Тур.	Max.	Unit
Off Charac	teristics	6							
				I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 25 <sup>o</sup> C			-	-	V
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage		age	$I_D = 250 \ \mu A, V_{GS} = 0 \ V, T_J = 150^{\circ}C$			650	-	V
∆BV <sub>DSS</sub> ′ ∆T <sub>J</sub>	Breakdown Voltage Temperature Coefficient		)	$I_D = 250 \ \mu$ A, Referenced to $25^{\circ}$ C		-	0.6	-	V/ºC
BV <sub>DS</sub>	Drain-Source Avalanche Breakdown Voltage			V <sub>GS</sub> = 0 V, I <sub>D</sub> = 16 A			700	-	v
	Zero Ga	te Voltage Drain Current		V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V		-	-	1	
DSS	Zero Gate Voltage Drain Current			V <sub>DS</sub> = 480 V, T <sub>C</sub> = 125 <sup>o</sup> C			-	10	μΑ
GSS	Gate to	Body Leakage Current		$V_{GS}$ = ±30 V, $V_{DS}$ = 0 V	/	-	-	±100	nA
On Charac	teristics	6							
V <sub>GS(th)</sub>	Gate Threshold Voltage			V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA	4	3.0	-	5.0	V
R <sub>DS(on)</sub>	Static D	Static Drain to Source On Resistance Forward Transconductance		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 8 \text{ A}$	-	0.55	0.26	Ω	
9 <sub>FS</sub>	Forward			$V_{DS} = 40 \text{ V}, \text{ I}_{D} = 8 \text{ A}$	-	11.5	-	S	
Dynamic C	haracte	ristics							
C <sub>iss</sub>		Input Capacitance					1730	2250	pF
C <sub>oss</sub>		Capacitance		$V_{DS} = 25 V, V_{GS} = 0 V,$		-	960	1150	pF
C <sub>rss</sub>		verse Transfer Capacitance		f = 1 MHz		-	85	-	pF
C <sub>oss</sub>		Capacitance		V <sub>DS</sub> = 480 V, V <sub>GS</sub> = 0 V	/. f = 1 MHz	_	45	60	pF
C <sub>oss(eff.)</sub>		al Gate Charge at 10V e to Source Gate Charge		$V_{DS} = 0 \text{ V to } 400 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 480 \text{ V}, I_D = 16 \text{ A},$ $V_{GS} = 10 \text{ V}$ (Note 4)		-	110	-	pF
Q <sub>g</sub>						-	55	70	nC
Q <sub>gs</sub>						-	10.5	13	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge					-	28	-	nC
ESR	Equivale	uivalent Series Resistance		f = 1 MHz		•	1.7	-	Ω
Switching	Charact	aristics			<u>.</u>				
	1					_	40	05	
d(on)	Turn-On Delay Time						42	85	ns
r <u> </u>	Turn-On Rise Time			$V_{DD}$ = 300 V, I <sub>D</sub> = 16 A, V <sub>GS</sub> = 10 V, R <sub>G</sub> = 25 Ω		-	130	270	ns
d(off)	_	Fall Time		$V_{GS} = 10$ V, $R_G = 25$ $\Omega$ (Note 4)		-	165 90	340 190	ns
f					(,	-	90	190	ns
		le Characteristics							
s		kimum Continuous Drain to Source Diode Forward Current				-	-	16	A
SM		num Pulsed Drain to Source Diode Forward Current				-	-	48	A
V <sub>SD</sub>		Source Diode Forward V	<b>C C C C C C C C C C</b>			-	-	1.4	V
rr O		Recovery Time		$V_{GS} = 0 V, I_{SD} = 16 A,$	05		435	-	ns
Q <sub>rr</sub> lotes:	Reverse	everse Recovery Charge		dI <sub>F</sub> /dt = 100 A/µs		-	7.0	-	μC





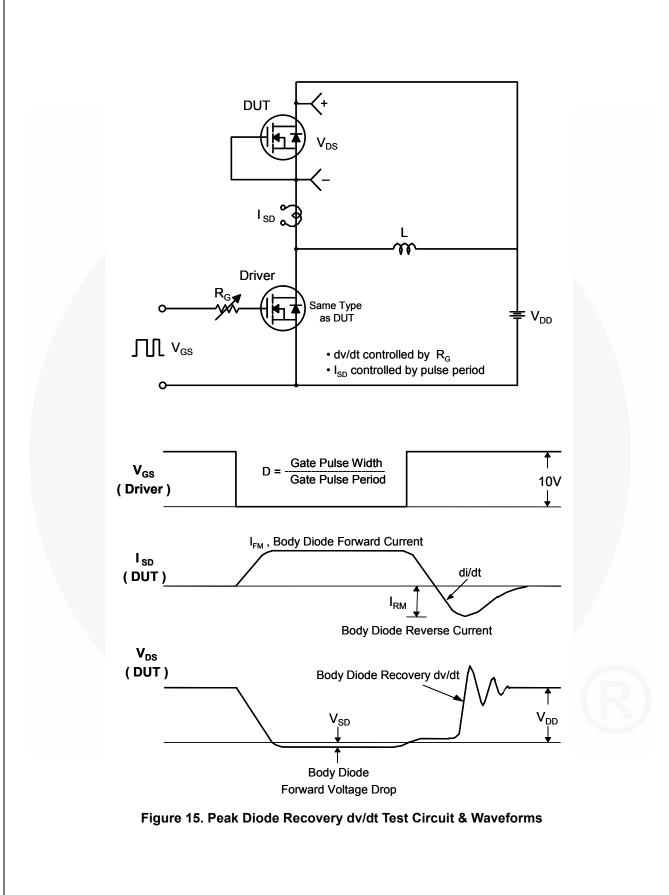
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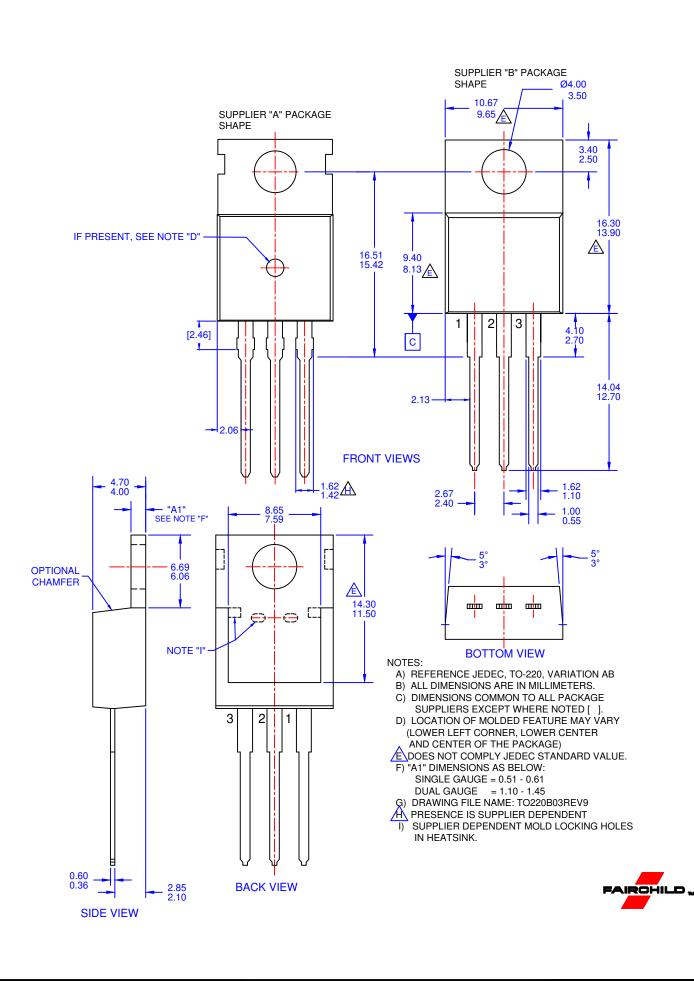


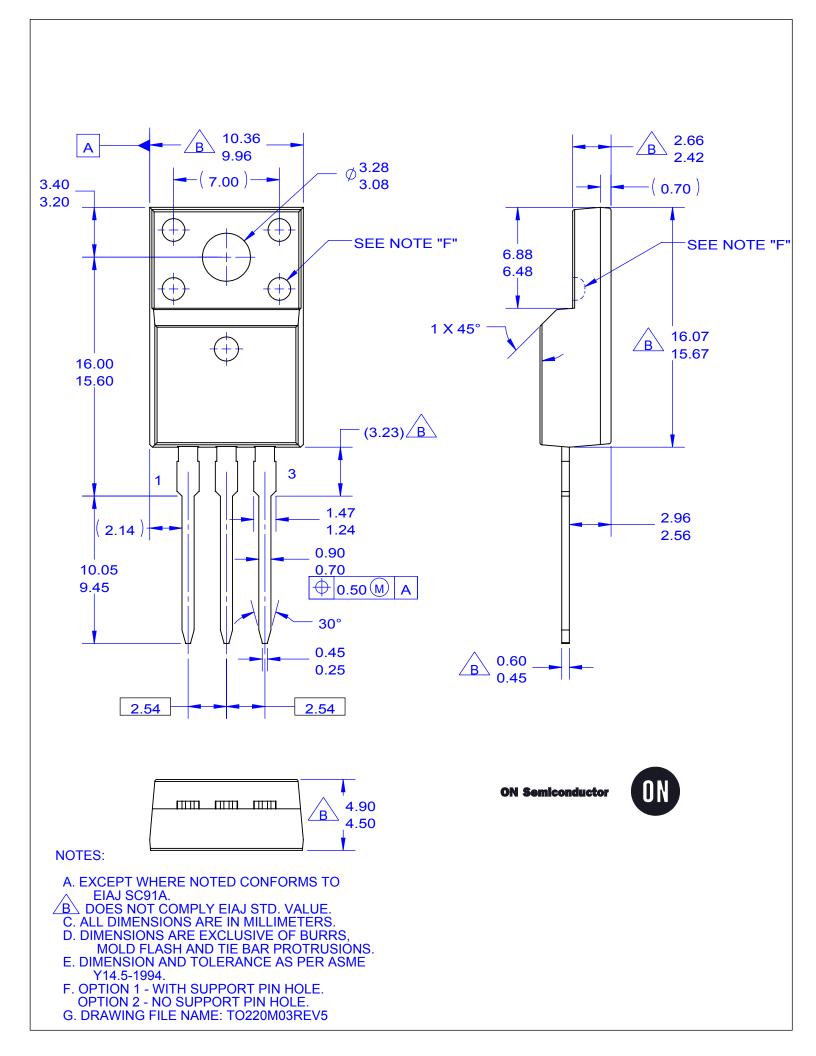
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